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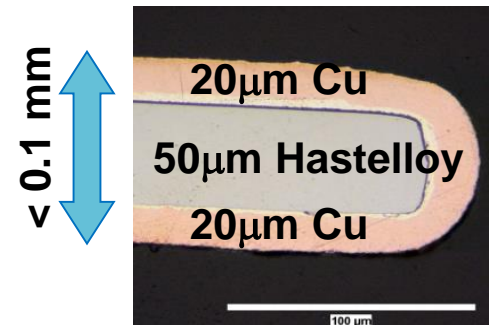
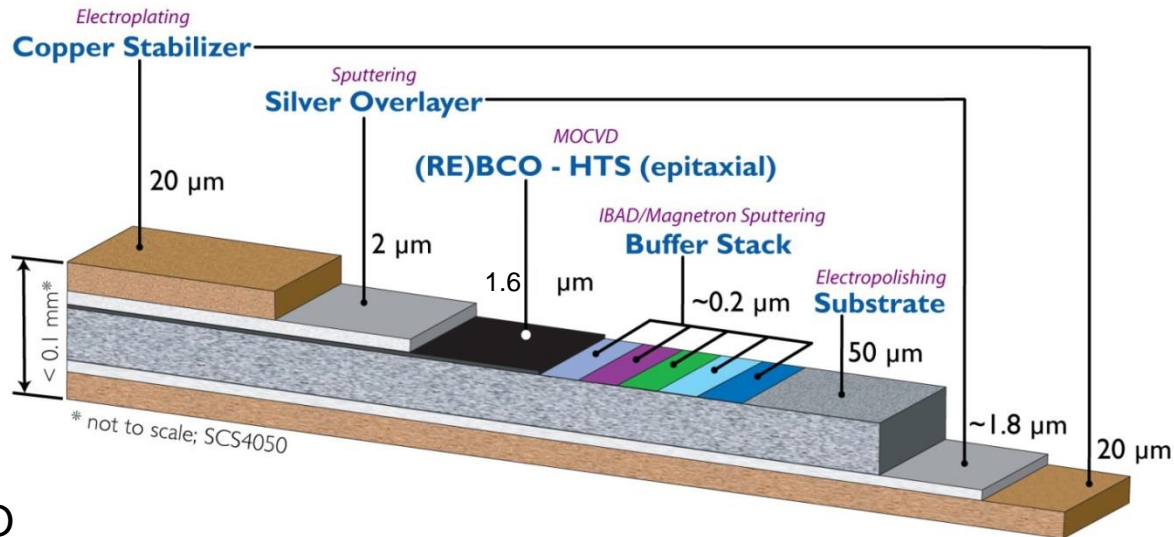
Progress of Wire Development and Process Improvement on 2G HTS at SuperPower

Drew W. Hazelton, Ryusuke Nakasaki, Satoshi Yamano, Masayasu Kasahara, Aarthi Sundaram, Yifei Zhang

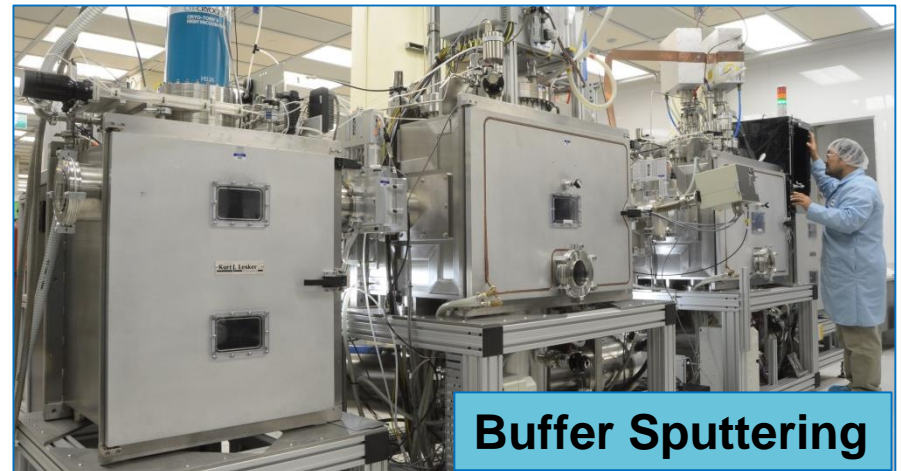
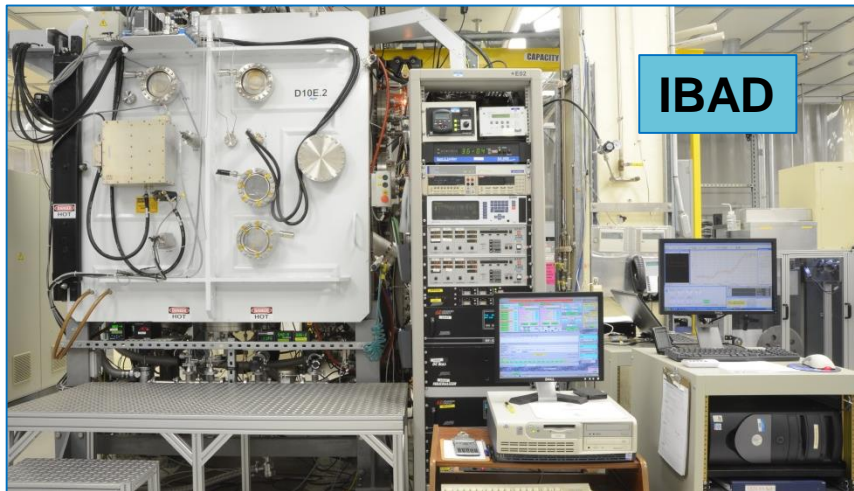
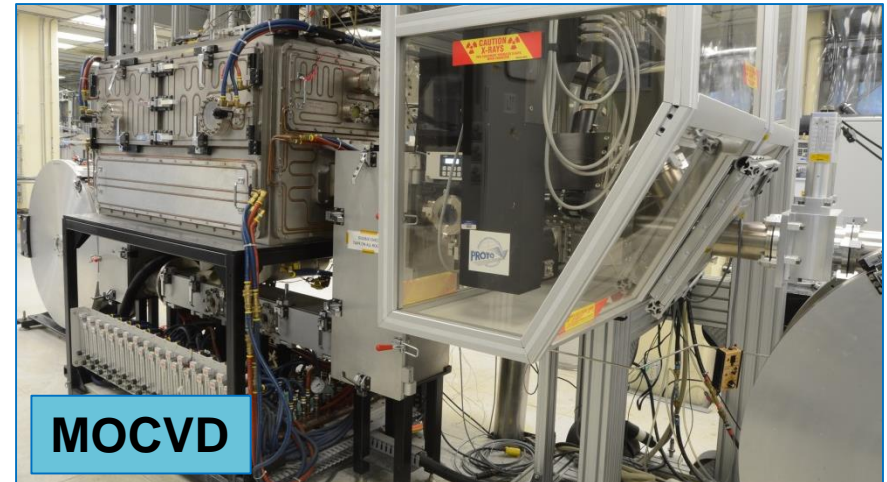
*Presentation 2MO4-02
September 19, 2017*

SuperPower's (RE)BCO superconductor with artificial pinning structure provides a solution for demanding applications

- Hastelloy® C276 substrate
 - high strength
 - high resistance
 - non-magnetic
- Buffer layers with IBAD-MgO
 - Diffusion barrier to metal substrate
 - Ideal lattice matching from substrate through REBCO
- MOCVD grown (RE)BCO layer with BZO nanorods
 - Flux pinning sites for high in-field I_c
- Silver and copper stabilization



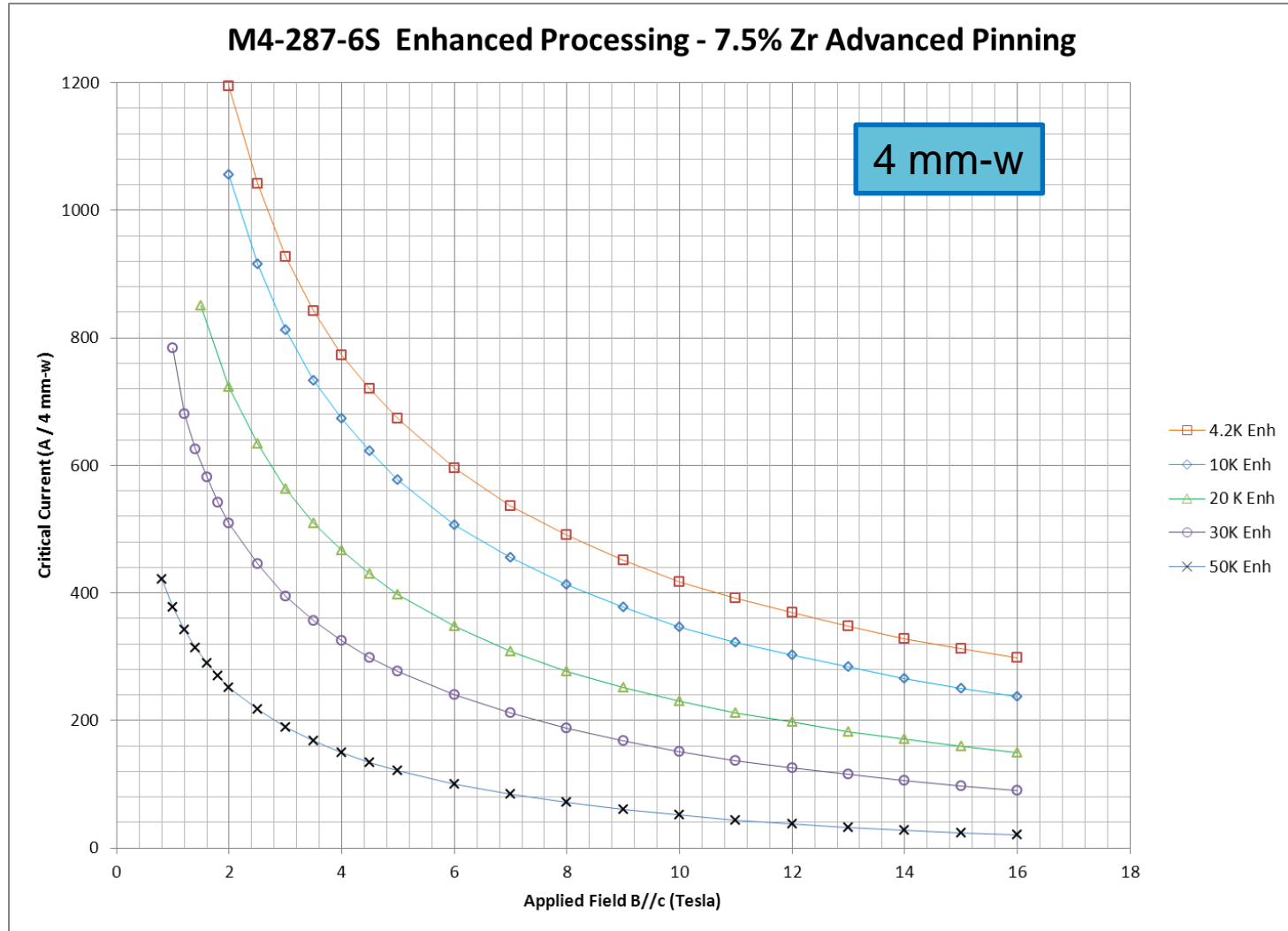
2G HTS wire has been produced with continuous upgrades at the manufacturing facility since 2006



Recent step wise improvements to meet market challenges

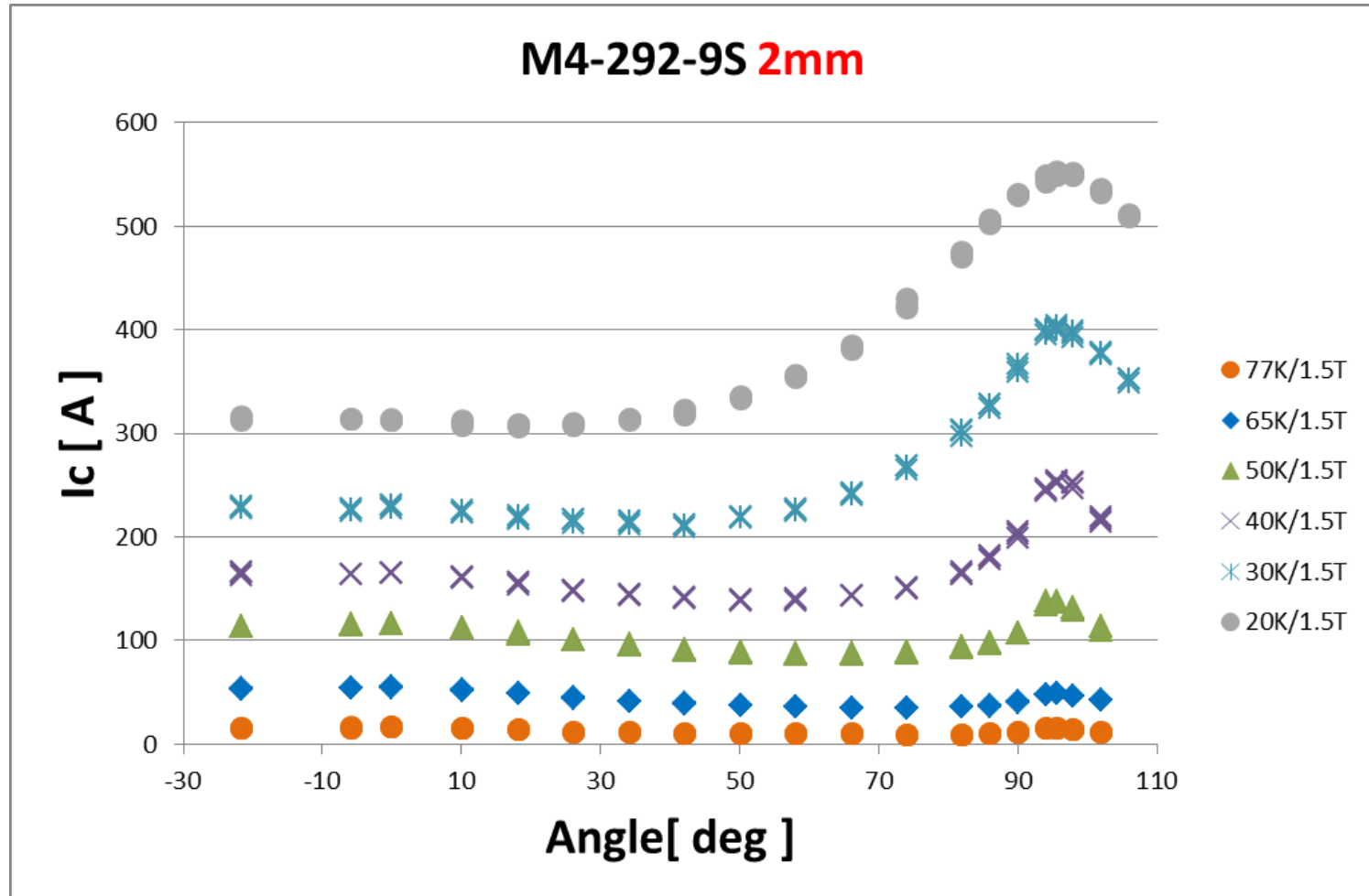
- **Critical current**
 - Recent advances in processing have significantly increased the base I_c (77K, sf) of SP 2G HTS tapes into the 400-600 A/cm-w range
- **Piece length**
 - Recent advances in processing have also increased the stable production piece length of SP 2G HTS tapes ~300m to 500 m
- **Current density**
 - SP 2G HTS tapes have some of the highest conductor J_c 's in the industry
 - New initiatives will continue to improve performance
 - Thinner substrates (>30% J_c improvements)
 - Improved lift factors (2x +) with enhanced pinning
 - Focus on three pinning regimes: 4K-high field, 20-50K – moderate field, 65-77K low field.
- **Continuous improvement of uniformity and reproducibility within and between run**

Critical current vs. field: enhanced 7.5% Zr AP

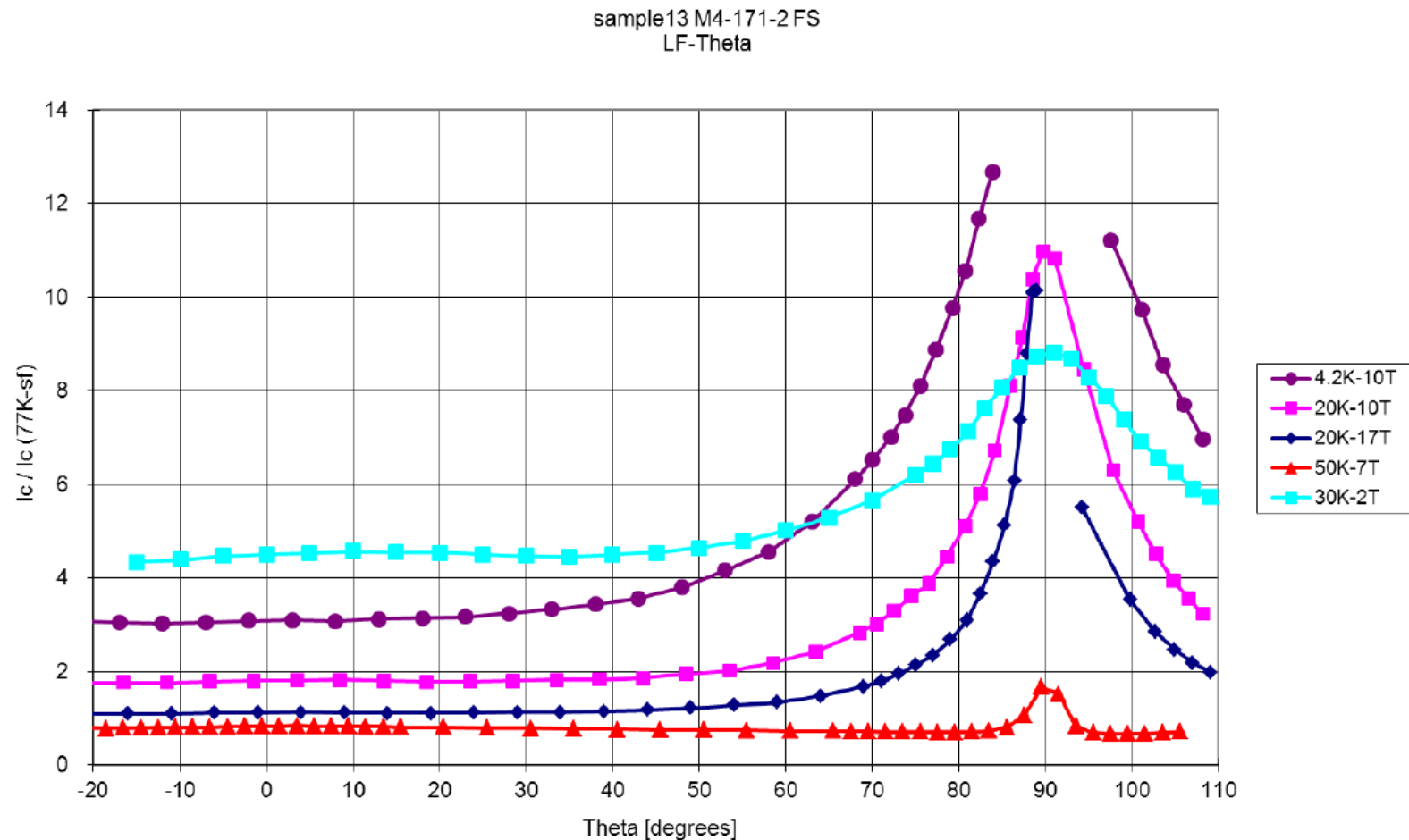


Measurements made at Tohoku University

IcBT typical data



High field IcBT data on 7.5% Zr doped sample

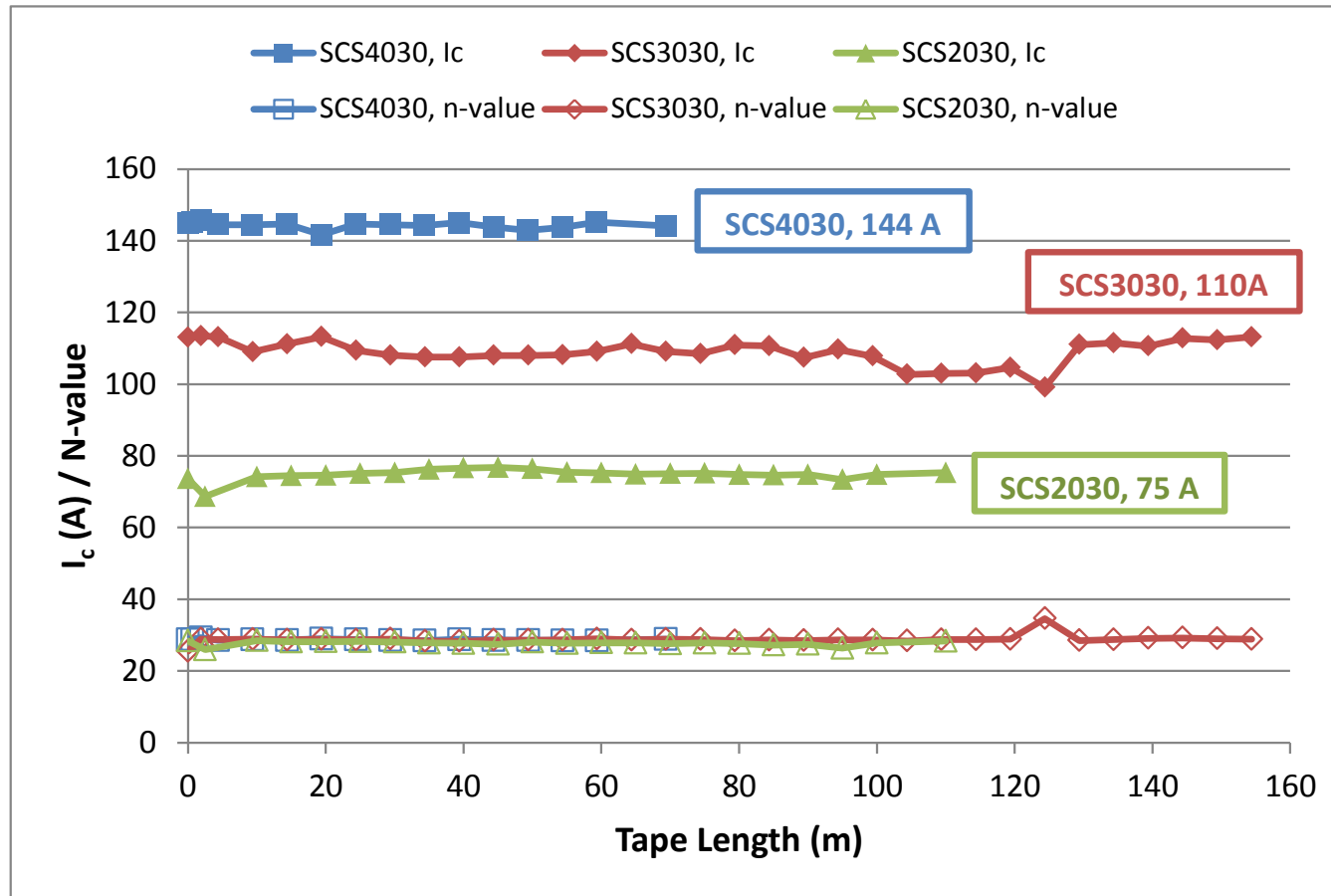


Measured at Tohoku Univ

Comprehensive testing capabilities for mechanical and electromechanical properties

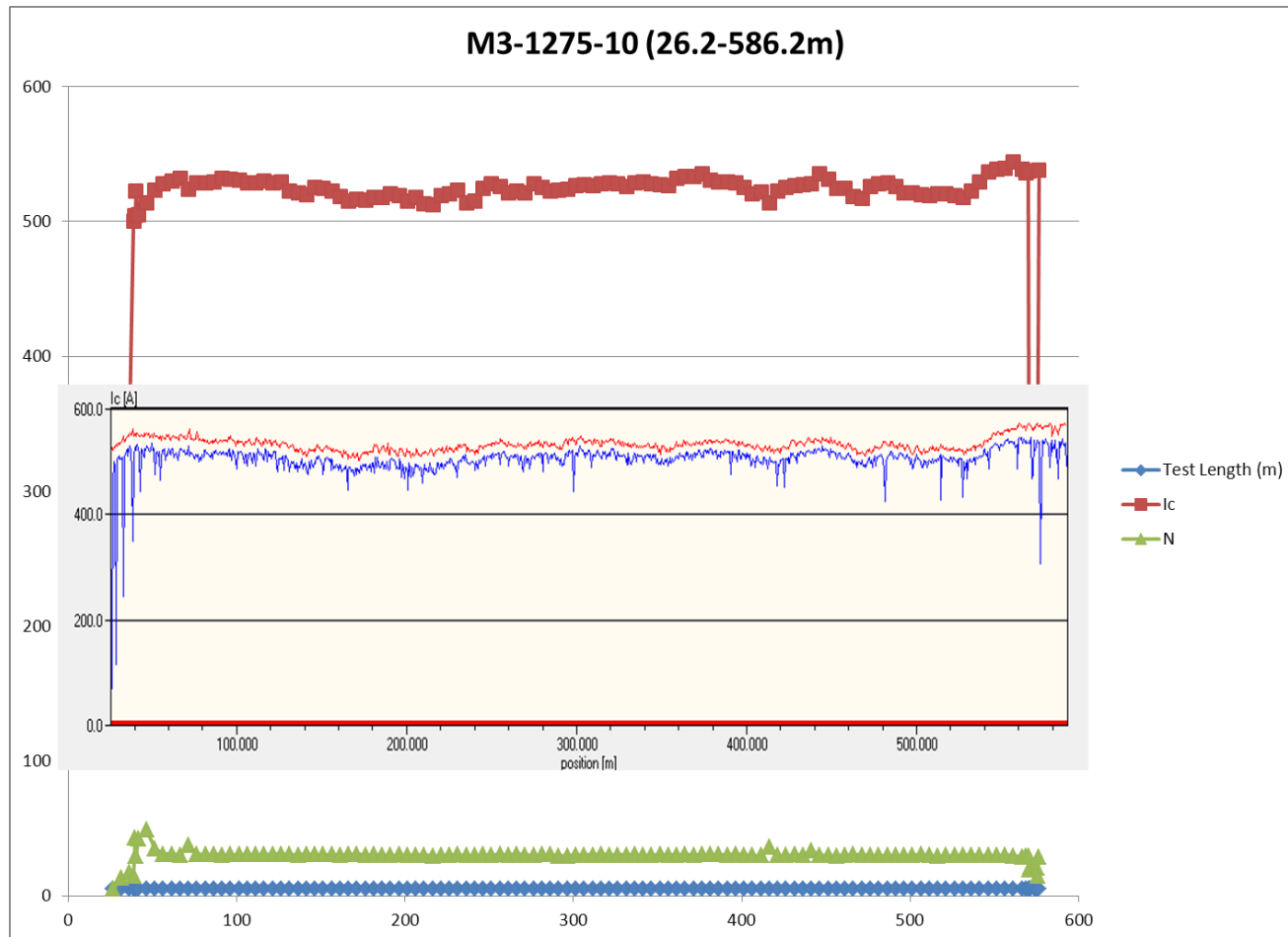
- Axial tensile test at room temperature or at 77K (with I_c)
 - Measurement of elastic modulus and yield stress
 - Determination of critical stress and irreversible stress (strain)
- Measurement of delamination strength – various testing methods
 - Peel test: at room temperature and with varying peeling angle
 - Pin-pull (c-axis tensile) test: at room temperature
 - Anvil (c-axis tensile) test: at room temperature or at 77K (with I_c)
- Transverse (c-axis) compressive test at 77K (with I_c)
 - Measurement of critical compressive stress
- Torsion-tension test at 77K (with I_c)
 - Measurement of critical tensile stress under twist

Development progress of 30 μ m substrate



- Base performance of 30 μ m substrates are comparable to 50 μ m
- Routine production in place

Recently delivered ~500m length w/ $I_c > 525\text{A}$ on $30\text{ }\mu\text{m}$ substrate



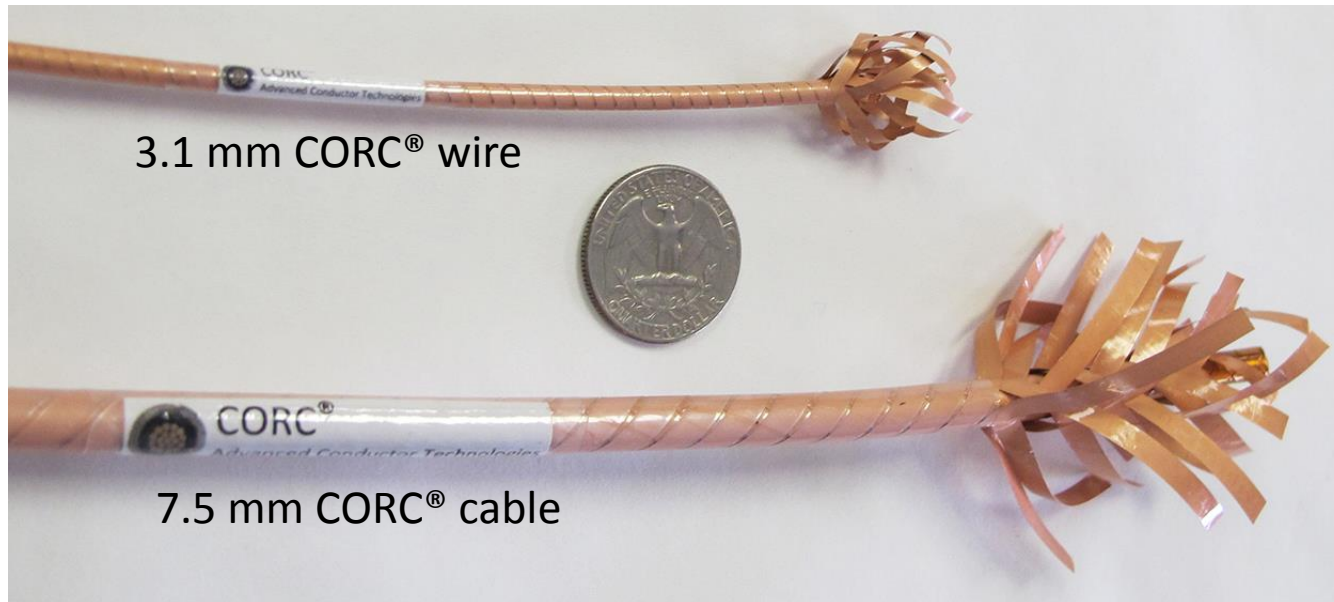
CORC® Cables and Wires

Advanced Conductor Technologies

- Developing high-current CORC® cables and wires
- CORC® performance tailored to each application
- Rotating machines will focus on CORC® wires



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CORC® cables

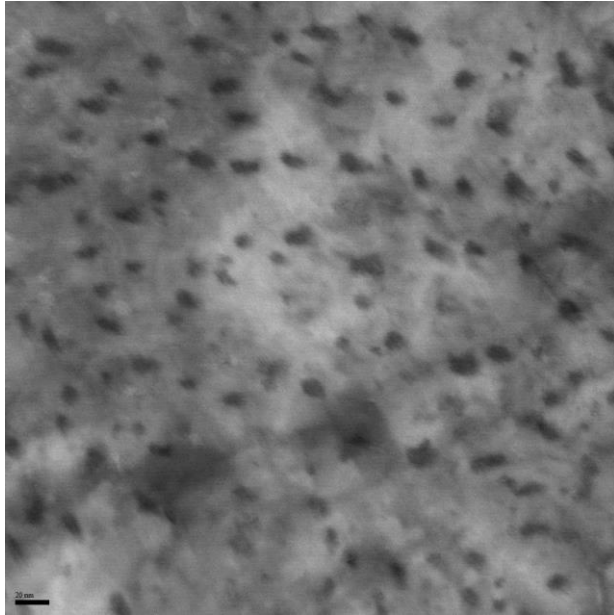
- Cable diameter 5 – 8 mm
- 20 - 30 mm twist pitch
- Wound from 4 mm wide tapes

CORC® wires

- Wire diameter 2.5 – 4.5 mm
- 6 - 10 mm twist pitch
- Wound from 2 mm wide tapes

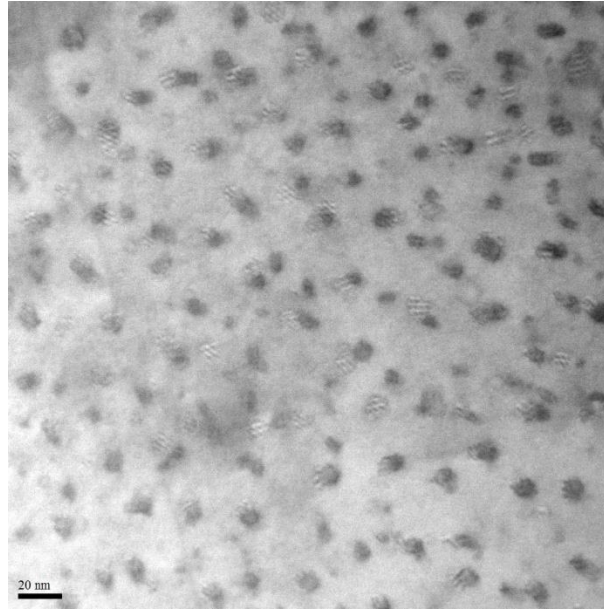
TEM analysis for enhanced Zr doping

Zr = 7.5%



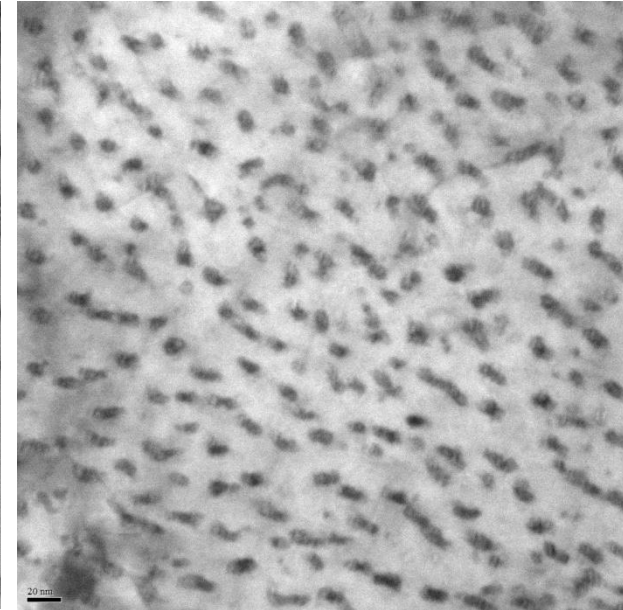
Size : 4.4~6.2nm
Distance: 20.8~26.8nm

Zr = 11.5%



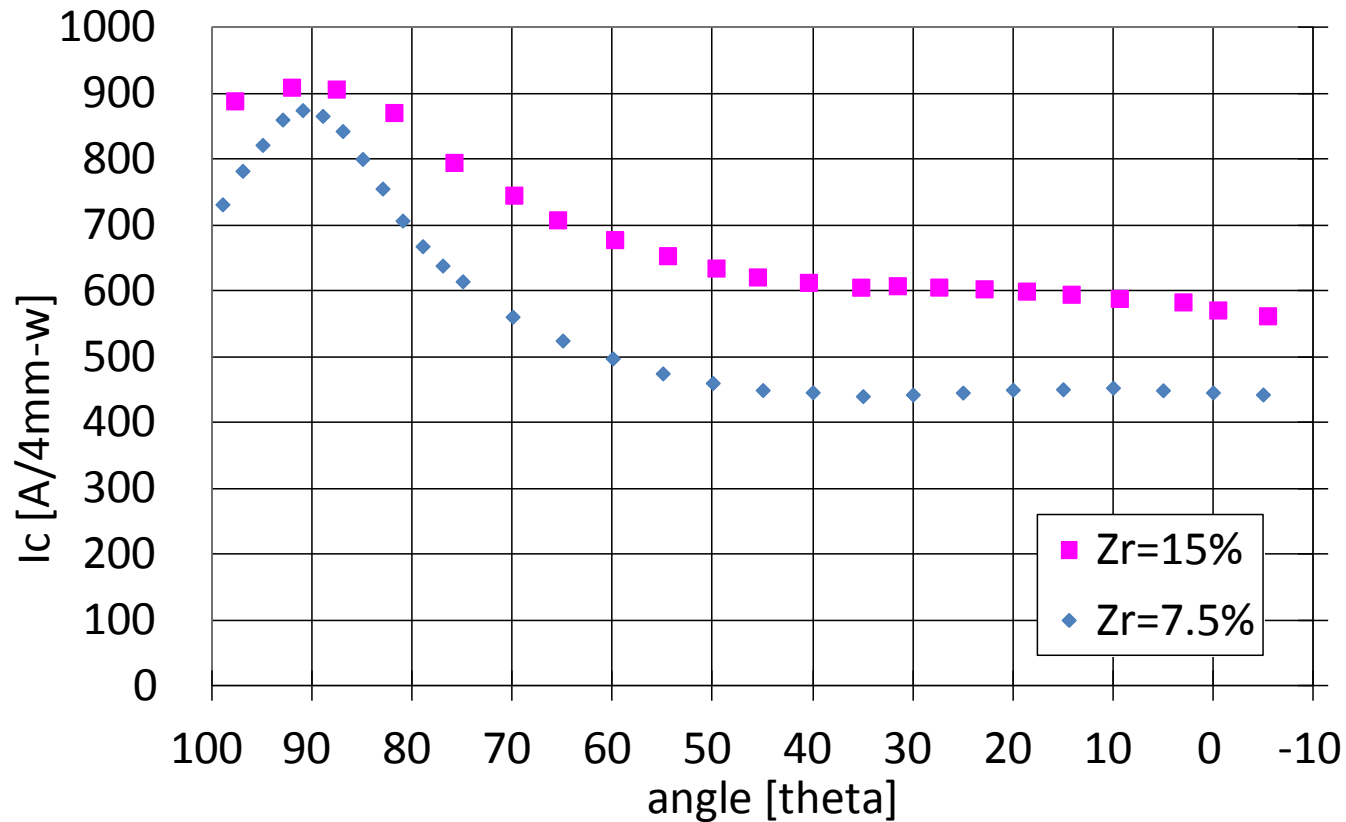
Size : 4.4~5.6nm
Distance: 16~20.7nm

Zr = 15%



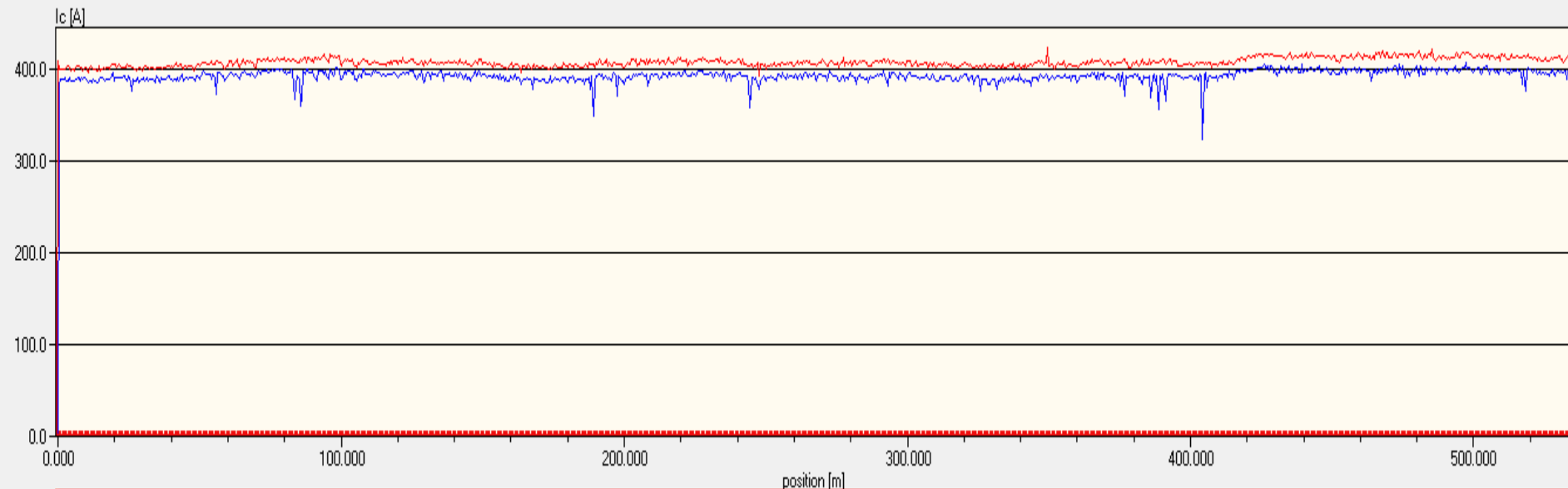
Size : 4.4~5.6nm
Distance: 12.8~18.3nm

In-field performance at 30K/2T



- 15% Zr doping samples show higher I_c performance in mid-field

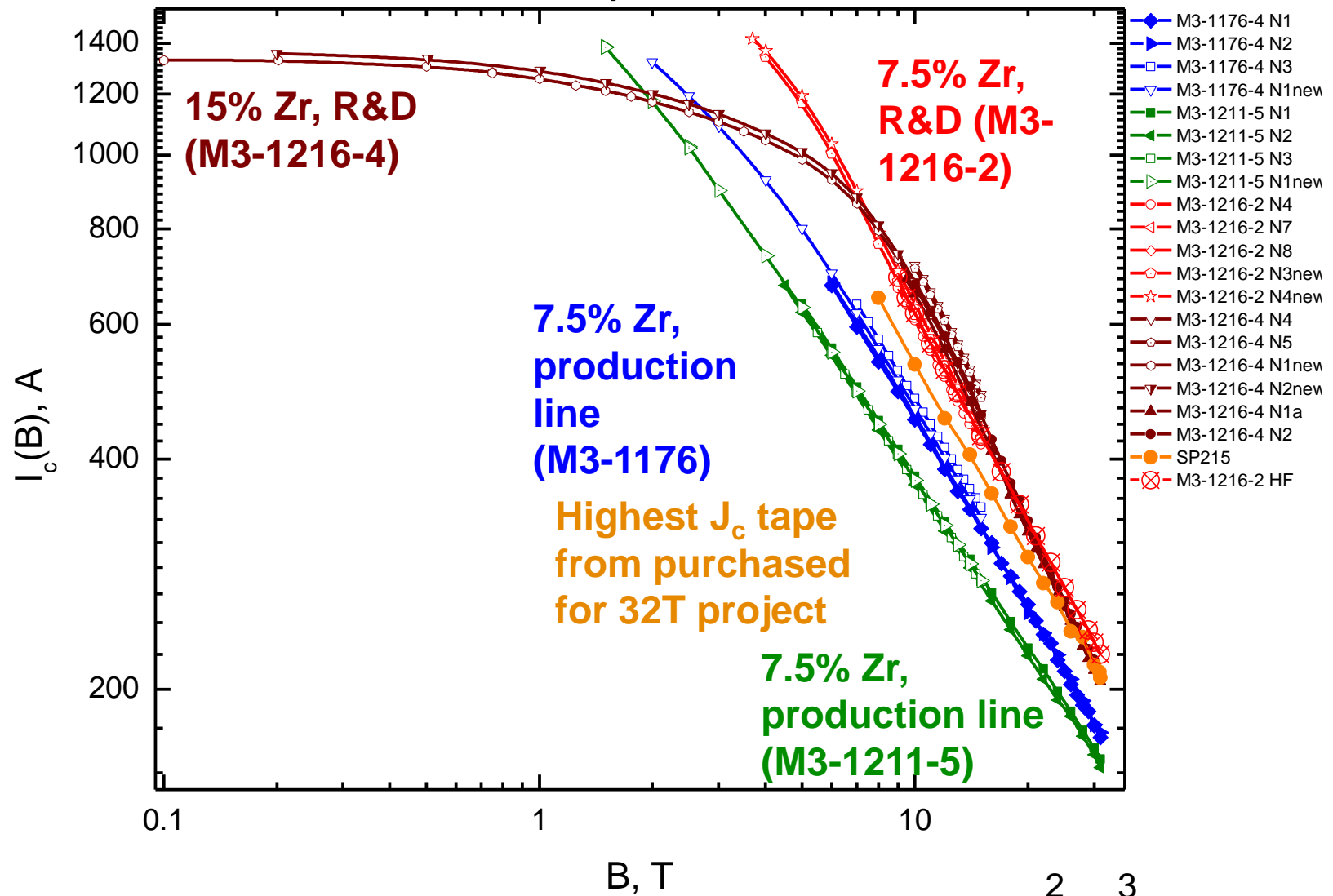
Long tapes with Zr = 15%



- Further work is underway before official release of Zr enhanced wires
 - Repeatability of I_c performance at 20~50K and 2T thru 5T
 - Dispersion of I_c performance
 - Mechanical property

Combination of $I_c(B, 4K)$ measured in resistive and superconducting magnets

Below $\approx 2T$ 15% Zr tape has lower I_c than 7.5% Zr production line tape



Summary

- Strong focus on processing to improve uniformity, repeatability, piece lengths and yield.
- Maximize current capacity while developing next generation equipment
 - When is the time to pull the trigger?
- Enhance performance parameters for developing operating spaces
 - Thinner substrates
 - Thicker films
 - Optimized pinning
- Continue to improve mechanical properties
 - Delamination mitigation
 - I_c (ϵ)



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Thank you for your attention